

PATENT
0171-1085PUS1

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: KOZAKAI, Shouhei et al Conf.:
Appl. No.: NEW Group:
Filed: April 22, 2004 Examiner:
For: DICING/DIE BONDING ADHESION TAPE

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

April 22, 2004

Sir:

The following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

This amendment includes:

Amendments to the Specification

Remarks.